

## High Voltage Ceramic Chip Capacitors Type CFH

### △ Features

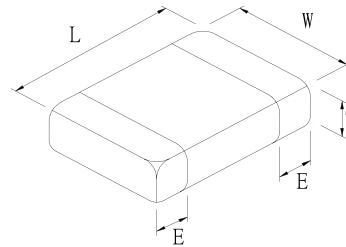
- Surface Mount
- Rated Voltage: 250 VAC, 3000VDC
- Chip Size: 1808, 1812

### △ Applications

- Suitable for wave and reflow soldering
- Use in mobile, facsimile, telephone and other telecom electronic equipment where lightning surges occur.

### △ Dimensions

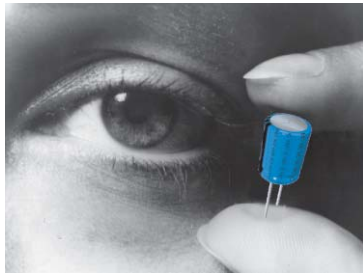
Size		1808	1812
(L) Length	mm	4.60±0.30	0.30± 4.60
	(in)	(0.181±0.12)	(0.12±0.181)
(W) Width	mm	2.00±0.20	0.20±3.20
	(in)	(0.080±0.008)	(0.008±0.126)
(E) Termination	mm	0.64±0.38	0.64±0.38
	(in)	(0.025±0.015)	(0.015±0.025)
(T) Thickness	mm	2.20	2.70
	(in)	(0.087)	(0.106)



### △ Specifications

	Size	Length / Width	Volt	Capacitance
X7R	1812	L: 4.60±0.030mm (0.181±0.012) W: 3.20±0.030mm (0.126±0.012)	250	300pF-2700pF X2Y3 - TUV/UL
	1808	L: 4.60±0.030mm (0.181±0.012) W: 2.00±0.020mm (0.080±0.008)	250	150pF-1000pF X2Y3 - SEMKO
			250	150pF-1800pF X2Y3 - TUV/UL
NPO	1808	L: 4.60±0.030mm (0.181±0.012) W: 2.00±0.020mm (0.080±0.008)	250	5.0pF-220pF X2Y3 - SEMKO
			250	3pF-1000pF X2Y3 - TUV/UL

Surface Mount Capacitors

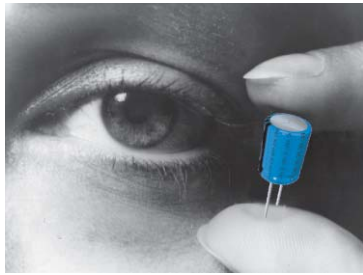


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Δ Electrical

Test	Test Conditions	Post-Test Inspection Requirements
<b>Temperature Coefficients</b>	Operating temp. range: -55 to +125°C	<b>Class I:</b> ΔC: 0±30ppm/°C <b>Class II:</b> ΔC: ≤ ±15%
<b>Capacitance</b>	<b>Class I:</b> 1MHz, 1Vrms <b>Class II:</b> 1KHz, 1Vrms	Capacitance is within specified tolerance
<b>Dissipation Factor (D.F.) and Tangent of Loss Angle (tanδ)</b>	<b>Class I:</b> 1MHz, 1Vrms <b>Class II:</b> 1KHz, 1Vrms	<b>Class I:</b> ≤ 0.1% <b>Class II:</b> ≤ 2.5%
<b>Insulation Resistance (I.R.)</b>	<b>Class I:</b> After 60 sec charging at 500V (DC) 25°C, 55% RH max. <b>Class II:</b> After 60 sec charging at 500V (DC) 25°C, 55% RH max.	<b>Class I:</b> ≥100GΩ or ≥1000MΩ.μF Whichever is smaller <b>Class II:</b> ≥10GΩ or ≥100MΩ.μF Whichever is smaller
<b>Impulse Voltage</b>	Each Individual Capacitor shall be subjected to a 2.5KV(X2/Y3) impulse	No breakdown or failure
<b>Withstanding Voltage</b>	Test 1.5KV AC for 60 sec	No breakdown or failure

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Δ Environmental

Test	Test Conditions	Post-Test Inspection Requirements
<b>Solderability</b>	Immersed in Solder bath at $245 \pm 5^\circ\text{C}$ for $5 \pm 0.5$ sec.	No Visible Damage At least 75% of termination area should be well tinned
<b>Resistance to Soldering Heat</b>	Immersed in Solder bath at $245 \pm 5^\circ\text{C}$ for $5 \pm 0.5$ sec. Recovery: $12 \pm 1$ hr.	No Visible Damage <b>Class I:</b> $\Delta\text{C}/\text{C}$ : $\leq \pm 2.5\%$ or $0.25\text{pF}$ whichever is larger I.R.: More than $10\text{G}\Omega$ D.F.: $\leq 2.5\%$ <b>Class II:</b> $\Delta\text{C}/\text{C}$ : $\leq 10\%$ I.R.: More than $1\text{G}\Omega$ D.F.: $\leq 2.5\%$
<b>Endurance (Life Test)</b>	Preconditioning $1000^{+48}_0$ hr. at upper category temperature applied at: $1.25U_R$ (X1,X2) or $1.7U_R$ (Y2,Y3) Once every hour the voltage shall be increased to $1000\text{Vrms}$ for 0.1 sec. Recovery: $12 \pm 1$ hr.	No Visible Damage <b>Class I:</b> $\Delta\text{C}/\text{C}$ : $\leq \pm 5\%$ I.R.: More than $1\text{G}\Omega$ D.F.: $\leq 0.25\%$ <b>Class II:</b> $\Delta\text{C}/\text{C}$ : $\leq 10\%$ I.R.: $\geq 1\text{G}\Omega$ or $50\text{M}\Omega \cdot \mu\text{F}$ whichever is smaller D.F.: $\leq 2.5\%$
<b>Humidity Test (Damp heat, steady state)</b>	Preconditioning $500^{+24}_0$ hr. at $40 \pm 2^\circ\text{C}$ , 90~95% relative humidity. The capacitor with rated voltage ( $250\text{VAC}$ ) applied. Recovery: $12 \pm 1$ hr.	No Visible Damage <b>Class I:</b> $\Delta\text{C}/\text{C}$ : $\leq \pm 5\%$ or $0.5\text{pF}$ whichever is larger I.R.: More than $10\text{G}\Omega$ D.F.: $\leq 2.5\%$ <b>Class II:</b> $\Delta\text{C}/\text{C}$ : $\leq 10\%$ I.R.: $\geq 1\text{G}\Omega$ or $50\text{M}\Omega \cdot \mu\text{F}$ whichever is smaller D.F.: $\leq 5\%$
<b>Adhesion Strength of Termination</b>	Capacitors mounted on a substrate. A force of $5\text{N}$ applied perpendicular to the place of substrate and parallel the line joining the center of terminations for $10 \pm 1$ sec.	No Visible Damage
<b>Resistance to Flexure Stress</b>	Capacitors mounted on a substrate. The board shall then be bent by $1\text{mm}$ at a rate of $1\text{mm}/\text{sec}$ .	No Visible Damage Change in capacitance is less than 10%
<b>Active Flammability</b>	The capacitor is applied $U_R(250\text{VAC})$ . Then each sample shall be subjected to 20 discharges from a tank capacitor, charge to a voltage that, when discharged, places $U_i 2500\text{V}$ for $X_2Y_3$ , $U_i 5000\text{V}$ for $X_1Y_2$ across the capacitor under test. The interval between successive discharges shall be 5 sec.	The cheese cloth shall not burn with a flame.

Surface Mount Capacitors



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Δ Ordering

**CFH 1808 N - 100 J - 302 E D G**

**(1) (2) (3) (4) (5) (6) (7) (8) (9)**

(1)	Series	CFH: X2Y3
(2)	Size Code	1808
		1812
(3)	Dielectric Code	N: COG (1BCG)
		X: X7R (2R1)
(4)	Capacitance Code	Capacitance expressed in pF. First two digits are significant figures. The third Digit denotes number of zeros. Use R for decimal point for values less than 10pF. (eg. R47: 0.47pF)
(5)	Tolerance Code	Code Tolerance
		C ±0.25pF
		D ±0.5pF
		F ±1%
		G ±2%
		J ±5%
		K ±10%
		M ±20%
Z +80% -20%		
Other Tolerances Available Upon Request		
(6)	Rated Voltage Code	302: 3000V
(7)	Packaging Code	TR: Tape and Reel, Cardboard Tape
		ER: Tape and Reel, Embossed Tape
		No Code: Bulk
(8)	Thickness Code	Code Tolerance (mm)
		B 0.71-0.90
		C 0.91-1.30
		D 1.31-1.50
		E 1.51-1.80
		F 1.81-2.20
G 2.21-2.70		
(9)	Special Code	G: Cd/Pb Free

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Capacitors